

WHEN PERFORMANCE MATTERS

THE OPEN-CLOSED COOLING DRIVAER VARIANT WITH STATIC MESH CHALLENGE ON ADVANCED COMPUTING PLATFORMS

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E4 COMPUTER ENGINEERING











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TESTING ADVANCED COMPUTING PLATFORMS: THE FRONTIER BEYOND CURRENT HPC SOTA



AMD Genoa @E4

2x AMD EPYC 9554 (Genoa) x86 64

64 cores/processor (128 cores/node) 256 MB L3 cache/socket 500k MB DDR5-4800 RAM

> 360 W/processor Software stack GNU 12.4.0 Open MPI 4.1.4



NVIDIA Grace SuperChip @E4

2x Nvidia Grace Arm Neoverse V2 72 cores/processor (144 cores/node) 114 MB L3 cache/socket 450k MB LPDDR5 RAM

> 500 W/node Software stack GNU 13.3.0 Open MPI 5.0.3 Extra compiler flags -mcpu=native



INTEL Sapphire Rapids @IT41

2x Intel® Xeon® CPU Max 9468 x86 64

48 cores/processor (96 cores/node) 105 MB L3 cache/socket 256 GB DDR5-4800 RAM 128 GB HBM 350 W/processor

Software stack

GNU 11.3.0

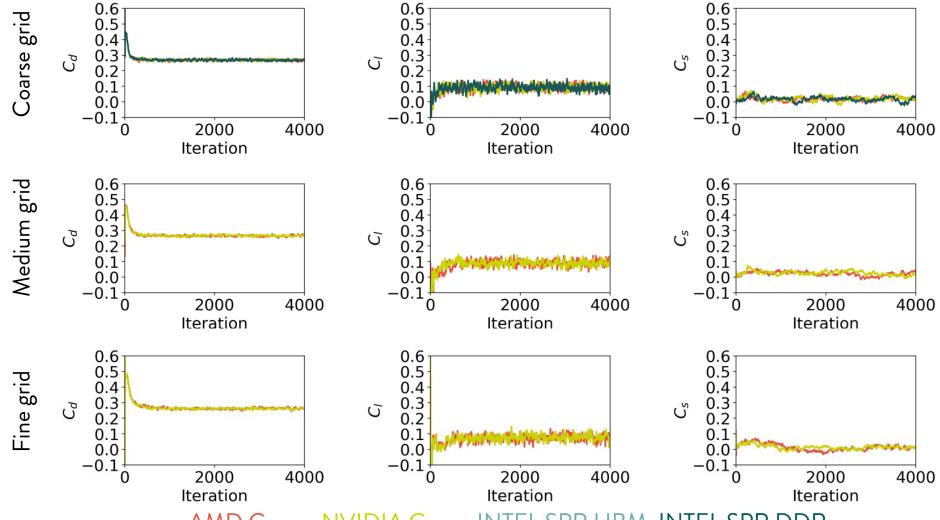
Open MPI 4.1.4

Extra compiler flags

- -march=sapphirerapids
- -mtune=sapphirerapids



PHYSICS RESULTS CONSISTENT ACROSS ALL ARCHITECTURES AND GRID CONFIGURATIONS

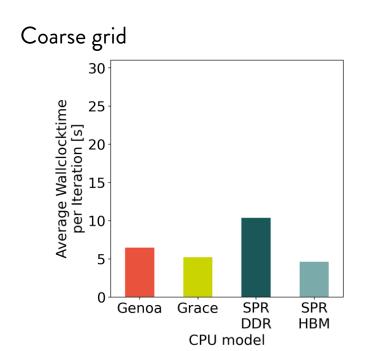


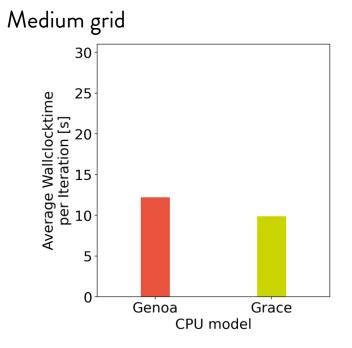


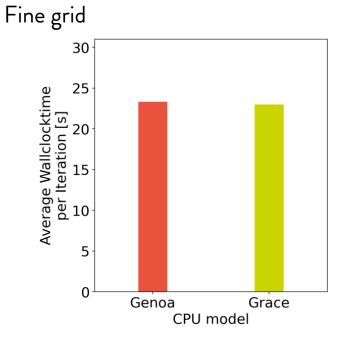
HBM ACCELERATES COMPUTATION BUT FACES MEMORY BOTTLENECKS ON MEDIUM/FINE GRIDS

Full node comparison

AMD Genoa: 128 cores, NVIDIA Grace: 144 cores, INTEL SPR DDR: 96 cores, INTEL SPR HBM: 96 cores





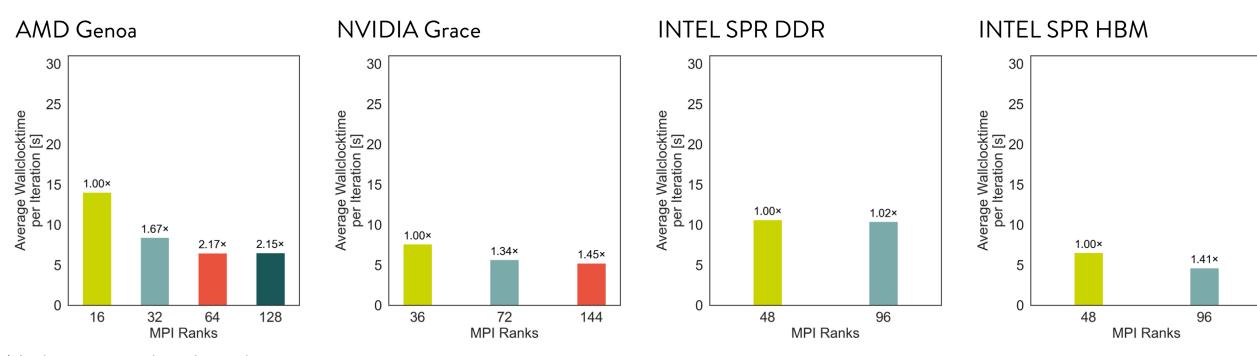


On INTEL SPR, binding to DDR numactl --membind 0-7, binding to HBM numactl --membind 8-15



FULL-NODE UTILISATION SHOWS LITTLE GAIN ON THE COARSE GRID

Coarse grid



Node requested exclusively Simulation launched with

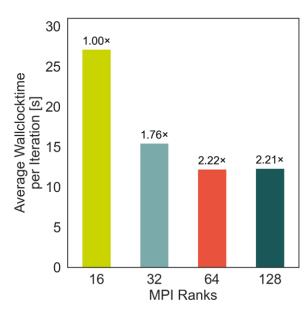
mpirun -np \${nProcs} --bind-to core --map-by ppr:\${nProcs}:node:PE=\${dist}
where nProcs is the number of MPI tasks and dist the number of processing elements assigned per process (total cores/nProcs)



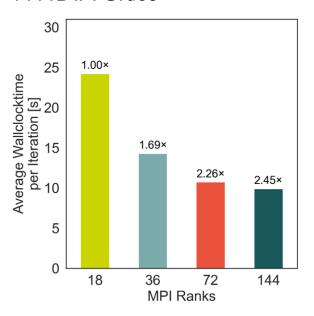
SCALABILITY WITH THE MEDIUM GRID REMAINS POOR ON BOTH AMD GENOA AND NVIDIA GRACE

Medium grid





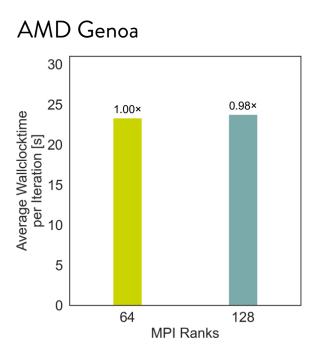
NVIDIA Grace



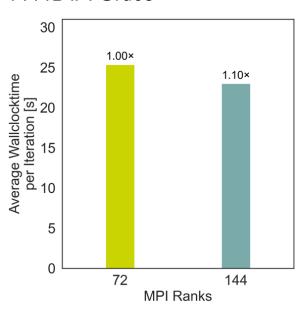


USING HALF A NODE ON GENOA YIELDS BETTER PERFORMANCE ALSO WITH FINE GRID

Fine grid



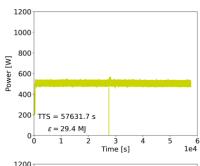
NVIDIA Grace

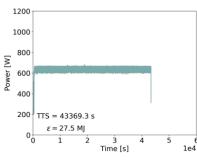


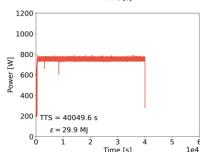


UNDER THESE NODE CONFIGURATIONS FASTER TTS TRANSLATES TO LOWER ENERGY CONSUMPTION

Power absorption time series on Grace







Coarse grid

Architecture	Cores	TTS [s]	Energy [MJ]
AMD Genoa	64	26435.4	19
NVIDIA Grace	144	21187.7	15.3
INTEL SPR	96	20957.1	13.7

Medium grid

Architecture	Cores	TTS [s]	Energy [MJ]
AMD Genoa	64	49793.7	35.9
NVIDIA Grace	144	39951.6	28.8

Fine grid

Architecture	Cores	TTS [s]	Energy [MJ]
AMD Genoa	64	94138.1	67.8
NVIDIA Grace	144	92777.8	66.8



SUMMARY

- We evaluated the Open-closed cooling DrivAer variant using a static mesh OpenFOAM simulation across a range of advanced computing platforms featuring both x86_64 and ARM CPUs.
- The physics results were consistent across all tested architectures and grid configurations.
- OpenFOAM performance benefits from the use of High-Bandwidth Memory (HBM), though parallel scalability remains suboptimal on all platforms and grid resolutions analysed.
- Among the available node configurations, shorter time-to-solution correlates with lower energy consumption.

